

Title (en)

Low profile modular phone jack and method of making same

Title (de)

Modulare Telefonsteckerbuchse mit niedrigen Profil und dessen Herstellungsverfahren

Title (fr)

Fiche modulaire téléphonique à profil basse et méthode de sa fabrication

Publication

**EP 0851538 A2 19980701 (EN)**

Application

**EP 97122933 A 19971229**

Priority

US 77447596 A 19961230

Abstract (en)

A modular phone jack (10) includes an outer dielectric housing (12) having a plug-receiving opening (26) formed in a forward mating end (28) of the housing. An inner dielectric insert (14) is positionable in the housing. A plurality of elongated terminals (16) are fixed to the dielectric insert. Each terminal includes a contact portion (16b) at one end extending diagonally into the plug-receiving opening and a tail portion (16c) at the opposite end extending from the housing. A comb structure (22a) secures the tail portions to the housing at predetermined spaced locations. A method of fabricating the modular phone jack (10) according to the above structure is contemplated. <IMAGE>

IPC 1-7

**H01R 23/02**

IPC 8 full level

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